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edacentrum workshop seeks European EDA networking

Christoph Hammerschmidt

EE Times Europe 04/03/2009 10:36 AM



MUNICH, Germany — Against the background of the economy crisis, Electronic Design Automation researchers are seeking to intensify their pan-European contacts. For this reason, German edacentrum will hold his edaWorkshop together with the Design Technology Conference (DTC) of the European research initiatives Medea+ and Catrene.

"If we want to maintain our leading position in design automation for nanoelectronic components, we need to network European design and application expertise in particular in times of crisis," said Wolfgang Rosenstiel, chairman of the edaWorkshop as well as of Catrene-DTC. The German industry association edacentrum, based in Hannover, is organizer of the edaWorkshop which will take place from May 26 through 28 in Dresden, concurrently and co-located with the DTC.

The event is intended to offer a forum for scientists, users and chip designers to discuss current issues and problem as well as solution approaches in today's electronic design automation.

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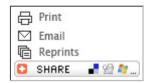
Giovanni de Micheli, professor and director of the Institute of Electrical Engineering and of the Integrated Systems Centre at EPF Lausanne (Switzerland) will discuss system level design techniques for distributed systems in his keynote speech.

Who distributed systems associated with automotive electronics is wrong in the case of de Micheli's speech: The professor will refer to design technologies required to design systems worn in the clothing. Applications could be, for instance, monitoring medical parameters of elerly people or convalescents.

Automotive electronics however will be discussed also at the event: Klaus Revermann, manager of Volkswagen's Body Electronics and Components division, will discuss the increasing complexity of automotive electronics landscapes against the background of also increasing safety and security requirements.

Another presentation, held by Dominique Henoff from STMicroelectronics, will focus on 3D integration of semiconductor devices for multimedia applications. A panel with Bosch's Peter van Staa, Rudy Lauwereins from the Belgian inter-university research center IMEC, Christian de Vries from NXP Bernd Ponick from the Hannover university discuss the industrial and research ecosystem required to design and build a European electric car.

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